



Microelectronics User Group Meeting

TWEPP 2019

2-6, September 2019

Santiago de Compostela, Spain

WELCOME!



Agenda

- “Welcome”
by Dr. Kostas Kloukinas (CERN) (5')
- “CHIPS: **CERN-HEP IC design Platform and Services**”
by Dr. Kostas Kloukinas (CERN) (15')
- “Europractice EDA tools for the HEP community”
by Dr. John McLean (Europractice STFC, UK) (15')
- “ASIC support News & Radiation Tolerant device models for 65nm technology”
by Dr. Alessandro Caratelli (CERN) (20')
- “Digital Library Characterization techniques”
by Maxime Barbe (CADENCE VCAD design services) (25')
- “Discussion”